COMPLIANT





High Precision Foil Resistor with TCR of ± 2.0 ppm/°C, Tolerance of ± 0.005 % and Load Life Stability of ± 0.005 %



INTRODUCTION

Bulk Metal[®] Foil (BMF) technology outperforms all other resistor technologies available today for applications that require high precision and high stability.

This technology has been pioneered and developed by VISHAY, and products based on this technology are the most suitable for a wide range of applications. BMF technology allows us to produce customer orientated products, designed to satisfy challenging and specific technical requirements.

Model S series made from Vishay BMF offers low TCR, excellent load life stability, tight tolerance, fast response time, low current noise, low thermal EMF and low voltage coefficient, all in one resistor.

The S series is virtually insensitive to destabilizing factors. The resistor element is a solid alloy that displays the desirable bulk properties of its parent material, thus it is inherently stable and noise free.

Vishay's Bulk Metal[®] S series resistors are the modern generation of precision resistors. The standard design of these resistors provides a unique combination of characteristics found in no other single resistor.

Our application engineering department is available to advise and to make recommendations. For non-standard technical requirements and special applications, please contact us.

TABLE 1 - RESISTANCE VERSUS TCR (- 55 °C to + 125 °C, + 25 °C ref.)					
RESISTOR	RESISTANCE VALUE (Ω)	TYPICAL TCR AND MAX SPREAD (ppm/°C)			
S102(C)	80 to < 150K	± 2 ± 2.5			
S102(K)	80 to < 100K	± 1 ± 2.5			
S102(C)	50 to < 80	± 2 ± 3.5			
S102(K)	50 10 < 60	± 1 ± 3.5			
S102(C)	1 to < 50	± 2 ± 4.5			
S102(K)	1 10 < 50	± 1 ± 4.5			

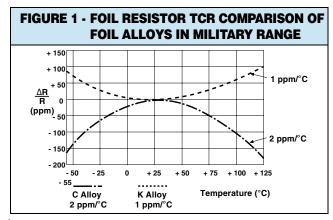
* Pb containing terminations are not RoHS compliant, exemptions may apply

FEATURES

- Temperature coefficient of resistance (TCR):
 55 °C to + 125 °C, 25 °C ref.
 - 55 °C to + 125 °C, 25 °C ret. - \$1020 series: + 2 ppm/°C typical (see table.
 - S102C series: ± 2 ppm/°C typical (see table 1)
 S102K series: ± 1 ppm/°C typical (see table 1)
- Rated power: to 1 W at + 125 °C
- Tolerance: ± 0.005 % (50 ppm)
- Load life stability: to ± 0.005 % at 70 °C, 2000 h at rated power
- Resistance range: 0.5 Ω to 1 M Ω (higher or lower values of resistance are available)
- Vishay Foil resistors are not restricted to standard values; specific "as required" values can be supplied at no extra cost or delivery (e.g. 1K2345 vs. 1K)
- Electrostatic discharge up to 25 000 V
- Non inductive, non capacitive design
- · Rise time: 1 ns effectively no ringing
- Current noise: 0.010 μV_{RMS}/V of applied voltage (< 40 dB)
- Thermal EMF: 0.05 μV/°C typical
- Voltage coefficient: < 0.1 ppm/V
- Low inductance: < 0.08 μH typical
- Non hot spot design
- Terminal finish: lead (Pb)-free or tin/lead alloy
- Matched sets are available per request (TCR tracking: to 0.5 ppm/°C)
- Prototype quantities available in just 5 working days or sooner. For more information, please contact foil@vishav.com
- For better TCR and PCR performances please review the Z201 datasheet

APPLICATIONS

- High precision amplifiers
- Down-hole (high temperature)
- High precision instrumentation
- · Medical and test equipment
- Industrial
- Audio (high end stereo equipment)
- EB applications (electron beam scanning and recording equipment, electron microscopes)
- Military, airborne
- Measurement instrumentation

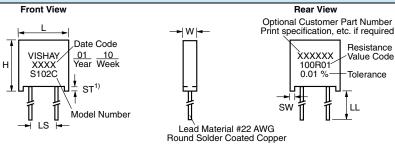


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FIGURE 2 - STANDARD IMPRINTING AND DIMENSIONS



Note

1. The standoffs shall be so located as to give a lead clearance of 0.010" minimum between the resistor body and the printed circuit board when the standoffs are seated on the printed circuit board. This is to allow for proper cleaning of flux and other contaminants from the unit after all soldering processes.

TABLE 2 - MODEL SELECTION									
MODEL NUMBER	RESISTANCE RANGE (Ω)	MAXIMUM WORKING VOLTAGE	AMBIENT POWER RATING		AVERAGE WEIGHT	DIMENSIONS			TIGHTEST TOLERANCE
			at + 70 °C	at + 125 °C	IN GRAMS	INCHES	mm	F ⁽¹⁾ (INCHES)	VS. LOWEST RESISTANCE VALUE
S102C (S102J) ⁽²⁾	1 to 150K		0.6 W up to	0.3 W 100K		W: 0.105 ± 0.010 L: 0.300 ± 0.010 H: 0.326 ± 0.010	2.67 ± 0.25 7.62 ± 0.25 8.28 ± 0.25		
S102K (S102L) ⁽²⁾	1 to 100K	300	0.4 W over	0.2 W 100K	0.6	ST: 0.010 min. SW: 0.035 ± 0.010 LL: 1.000 ± 0.125 LS: 0.150 ± 0.0054	0.254 min. 1.02 ± 0.13 25.4 ± 3.18 3.81 ± 0.13		
S104D (S104F) ⁽¹⁾	1 to 500K		1.0 W up to	0.5 W 200K		W: 0.160 max. L: 0.575 max. H: 0.413 max.	4.06 max. 14.61 max. 10.49 max.	(0.138)	
S104K	1 to 300K	350	0.6 W over	0.3 W 200K	1.4	ST: 0.035 ± 0.005 SW: 0.050 ± 0.005 LL: 1.000 ± 0.125 LS: 0.400 ± 0.020	0.889 ± 0.13 1.27 ± 0.13 25.4 ± 3.18 10.16 ± 0.51	(0.136) (0.565) (0.413)	0.005 %/50 Ω 0.01 %/25 Ω 0.02 %/12 Ω
S105D (S105F) ⁽¹⁾	1 to 750K		1.5 W up to	0.75 W 300K		W: 0.160 max. L: 0.820 max. H: 0.413 max.	4.06 max. 20.83 max. 10.49 max.	(0.138) (0.890) (0.413)	$0.05~\%/5~\Omega$ $0.1~\%/2~\Omega$ $0.50~\%/1~\Omega$
S105K	1 to 500K	350	0.8 W over	0.4 W 300K	1.9	ST: 0.035 ± 0.005 SW: 0.050 ± 0.005 LL: 1.000 ± 0.125 LS: 0.650 ± 0.020	0.889 ± 0.13 1.27 ± 0.13 25.4 ± 3.18 16.51 ± 0.51	(0.413) (0.7 ± 0.05)	0.30 /0/132
S106D	0.5 to 1M	500	2.0 W up to	1.0 W 400K		W: 0.260 max. L: 1.200 max.	6.60 max. 30.48 max.		
S106K	0.5 to 600K		1.0 W over	0.5 W 400K	4.0	H: 0.413 max. ST: 0.035 ± 0.005 SW: 0.050 ± 0.005 LL: 1.000 ± 0.125 LS: 0.900 ± 0.020	10.49 max. 0.889 ± 0.13 1.27 ± 0.13 25.4 ± 3.18 22.86 ± 0.51		

Notes

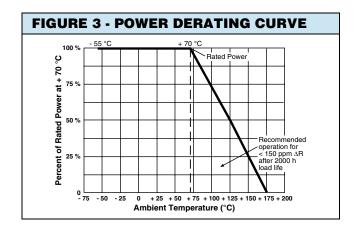
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⁽¹⁾ S104F and S105F have different package dimensions (see last column). All other specifications are the same.

 $^{^{(2)}}$ 0.200" (5.08 mm) lead spacing available - specify S102J for S102C, and S102L for S102K.





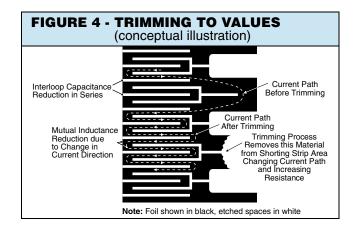


TABLE 3 - ENVIRONMENTAL PERFORMANCE COMPARISON				
	MIL-PRF-55182 CHAR J	S-SERIES MAXIMUM ∆R	S-SERIES TYPICAL AR	
Test Group I				
Thermal shock, 5 x (- 65 °C to + 150 °C)	± 0.2 %	± 0.01 % (100 ppm)	± 0.002 % (20 ppm)	
Short time overload, 6.25 x rated power	± 0.2 %	± 0.01 % (100 ppm)	± 0.003 % (30 ppm)	
Test Group II				
Resistance temperature characteristics	± 25 ppm/°C	± 4.5 ppm/°C	± 2.0 ppm/°C	
Characteristic				
Low temperature storage (24 h at - 65 °C)	± 0.15 %	± 0.01 % (100 ppm)	± 0.002 % (20 ppm)	
Low temperature operation (45 min, rated power at - 65 °C)	± 0.15 %	± 0.01 % (100 ppm)	± 0.002 % (20 ppm)	
Terminal strength	± 0.2 %	± 0.01 % (100 ppm)	± 0.002 % (20 ppm)	
Test Group III				
DWV	± 0.15 %	± 0.01 % (100 ppm)	± 0.002 % (20 ppm)	
Resistance to solder heat	± 0.1 %	± 0.01 % (100 ppm)	± 0.005 % (50 ppm)	
Moisture resistance	± 0.4 %	± 0.05 % (500 ppm)	± 0.01 % (100 ppm)	
Test Group IV				
Shock	± 0.2 %	± 0.01 % (100 ppm)	± 0.002 % (20 ppm)	
Vibration	± 0.2 %	± 0.01 % (100 ppm)	± 0.002 % (20 ppm)	
Test Group V				
Life test at 0.3 W/+ 125 °C				
2000 h	± 0.5 %	± 0.015 % (150 ppm)	± 0.01 % (100 ppm)	
10 000 h	± 2.0 %	± 0.05 % (500 ppm)	± 0.03 % (300 ppm)	
Test Group Va				
Life test at 0.6 W (2 x rated power)/+ 70 °C, 2000 h	± 0.5 %	± 0.015 % (150 ppm)	± 0.01 % (100 ppm)	
Test Group VI				
High temperature exposure (2000 h at + 175 °C)	± 2.0 %	± 0.1 % (1000 ppm)	± 0.05 % (500 ppm)	
Test Group VII				
Voltage coefficient	5 ppm/V	< 0.1 ppm/V	< 0.1 ppm/V	



STANDARD OPERATIONS AND TEST CONDITIONS

A. Standard Test Operations:

By 100 % Inspection

- Short-time overload (6.25 x rated power for 5 s)
- Resistance tolerance check
- Visual and mechanical

By Sample Inspection

- TCF
- Environmental tests per table 3 on a quarterly basis to establish performance by similarity
- B. Standard Test Conditions:
- Lead test point: 0.5" (12.7 mm) from resistor body
- Temperature: + 23 °C ± 2 °C
- Relative humidity: per MIL-STD-202

IMPROVED PERFORMANCE TESTING (IPT)

The preceding information is based on product directly off the production line. Improved performance (meaning increased time stability with load and other stresses) is available through factory conducted "Improved Performance Testing". The test routine is usually tailored to the users stability objectives and product that has been screened can be brought down to a potential load life of less than 50 ppm.

Various screen test routines are available and all anticipated stresses must be taken into account before settling on one specific test routine. Our applications engineering department is prepared to discuss and recommend appropriate routines given the full spectrum of anticipated stresses and stability requirements.

TABLE 4 - "S" SERIES SPECIFICATIONS				
Stability (1)				
Load life at 2000 h	± 0.015 % (150 ppm)	Maximum ΔR at 0.3 W/+ 125 °C		
	± 0.005 % (50 ppm)	Maximum ΔR at 0.1 W/+ 70 °C		
Load life at 10 000 h	± 0.05 % (500 ppm)	Maximum ΔR at 0.3 W/+ 125 °C		
	± 0.01 % (100 ppm)	Maximum ΔR at 0.05 W/+ 125 °C		
Current Noise	0.010 μV	(RMS)/V of applied voltage (- 40 dB)		
High Frequency Operation				
Rise time	1.0 ns at 1 kΩ			
Inductance (L) (2)	0.1 μH maximum; 0.08 μH typical			
Capacitance (C)	1.0 pF maximum; 0.5 pF typical			
Voltage Coefficient	< 0.1 ppm/V ⁽³⁾			
Thermal EMF ⁽⁴⁾	0.1 μV/°C	Maximum; 0.05 μV/°C typical		
	1 μV/W	(Model S102C)		

Notes

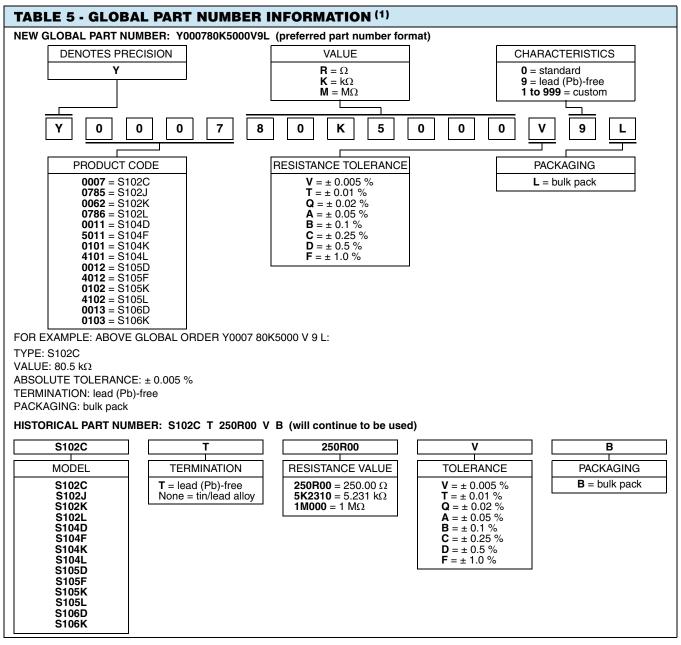
- (1) Load life ΔR maximum can be reduced by 80 %, please contact applications engineering department.
- (2) Inductance (L) due mainly to the leads.
- (3) The resolution limit of existing test equipment (within the measurement capability of the equipment, or "essentially zero".)
- (4) μV/°C relates to EMF due to lead temperature difference and μV/watt due to power applied to the resistor.

For any questions, contact: foil@vishay.com

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Note

(1) For non-standard requests, please contact application engineering.



Vishay

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